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501.36931X00
Expedited Procedure Requested
Amendment Under 37 CFR 1.116
Group 2813

22/944
3/8/02
2813
3/28/03
Munich

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): IWASAKI, et al.
Serial No.: 09/255,856
Filed: February 23, 1999
For: SEMICONDUCTOR DEVICE WITH LAYERED
INTERCONNECT STRUCTURE
Group: 2813
Examiner: S. Smoot

AMENDMENT AFTER FINAL REJECTION

Assistant Commissioner for Patents
Box AF
Washington, D.C. 20231

March 4, 2002

Sir:

In response to the Office Action mailed December 3, 2001, please amend
the above-identified application as follows:

IN THE CLAIMS

Please amend the claims presently in the application as follows:

O.K. to
Enter
S.W.S.
3-11-2002